

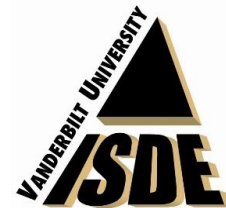
An abstract, flowing purple graphic in the top left corner, resembling a stylized flame or a dynamic liquid splash.

RADIATION HARDNESS OF MEMRISTIVE SYSTEMS

A. FANTINI

ON BEHALF OF IMEC RRAM TEAM AND VU ISDE TEAM

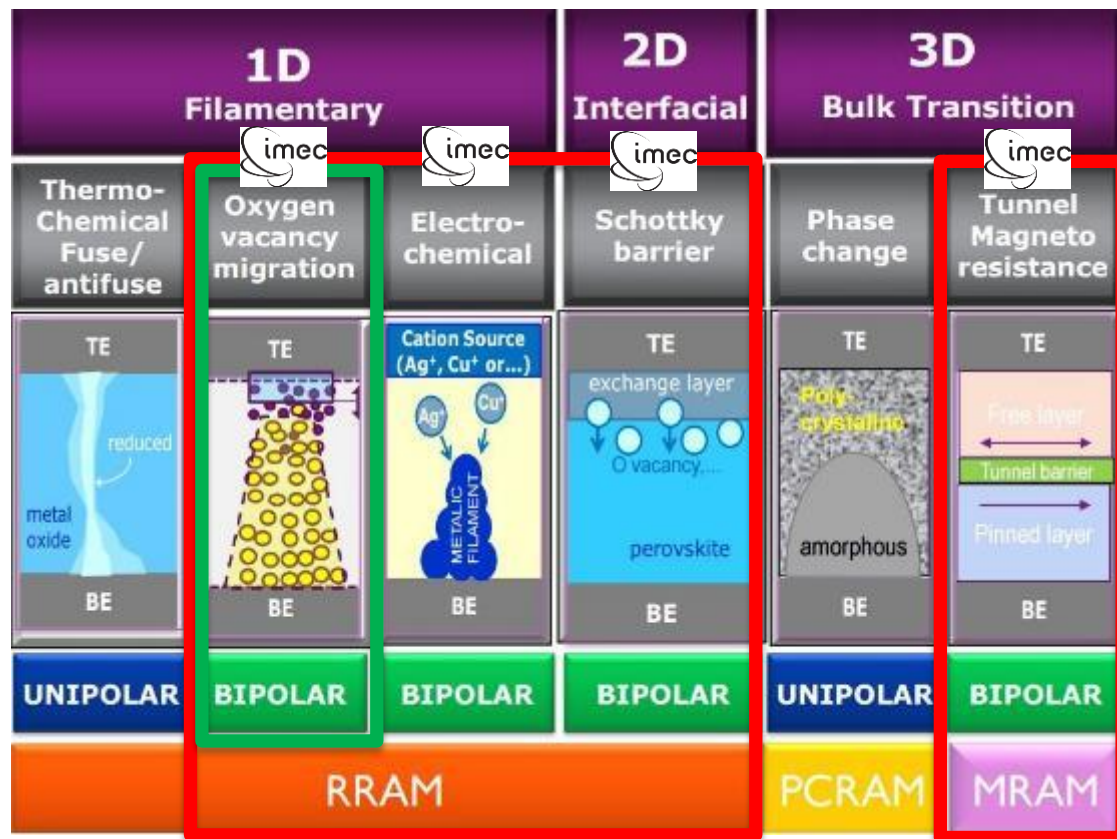
Workshop on Memristive systems for Space applications
ESTEC - 30/04/2015



OUTLINE

- ▶ Introduction
- ▶ RRAM for space application
- ▶ Reliability: SEU
- ▶ Reliability: TID/DD
- ▶ Conclusion

IMEC EMERGING MEMORY ACTIVITY

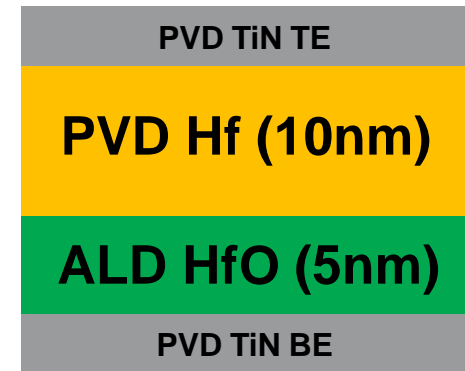
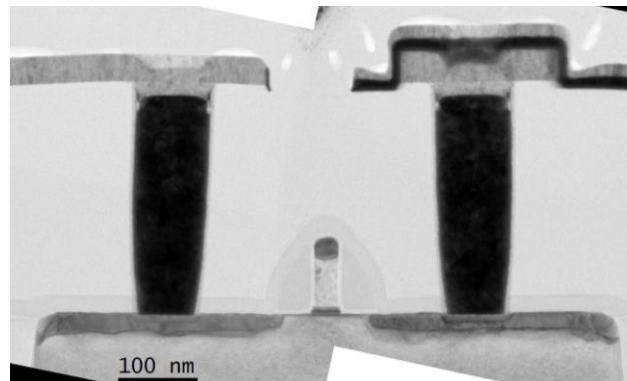
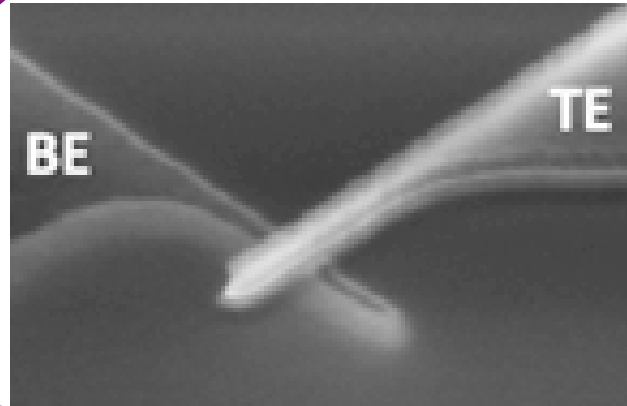
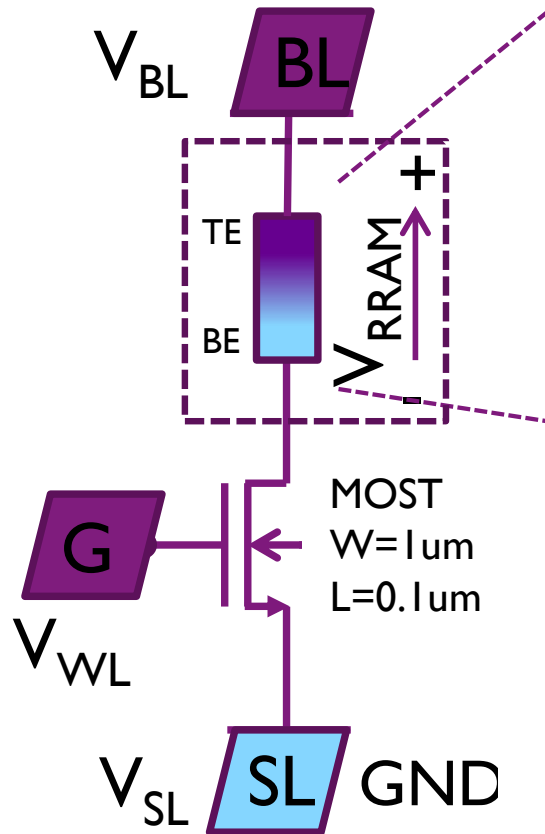


We will focus on
Oxide based RRAM
(OXRAM)

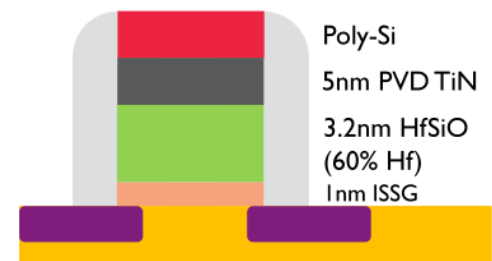
Vacancy migration
switching mechanism

- Several flavors of resistive memory technology at research stage in imec

OXRAM 1T1R CELL EXPERIMENTAL SAMPLE

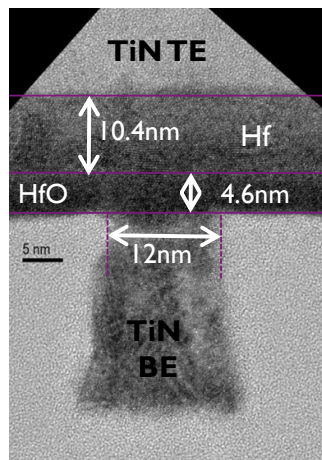


Crossbar device
RME 40x40nm

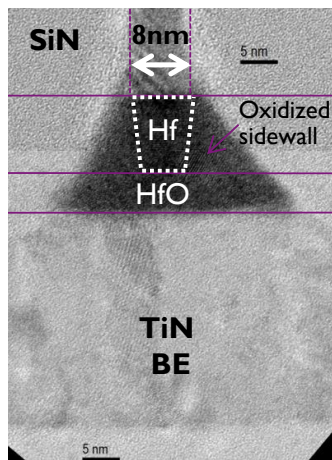


Unhardened 65nm
FEOL node

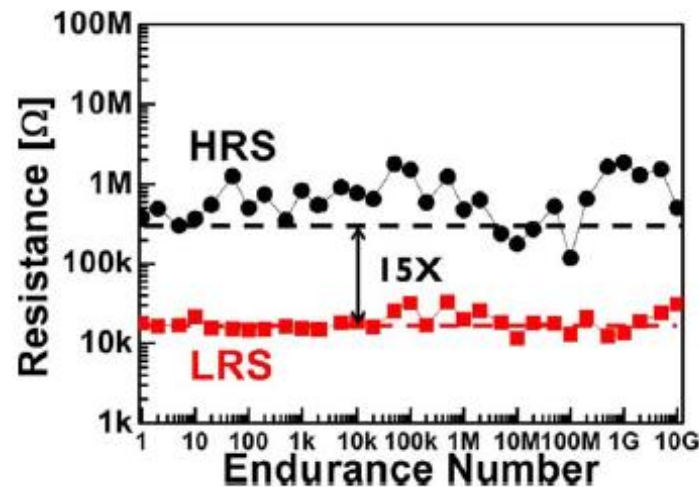
RRAM FEATURES



**Fully functional
sub 10nm device**



*Fantini et al.,
VLSI 2014*

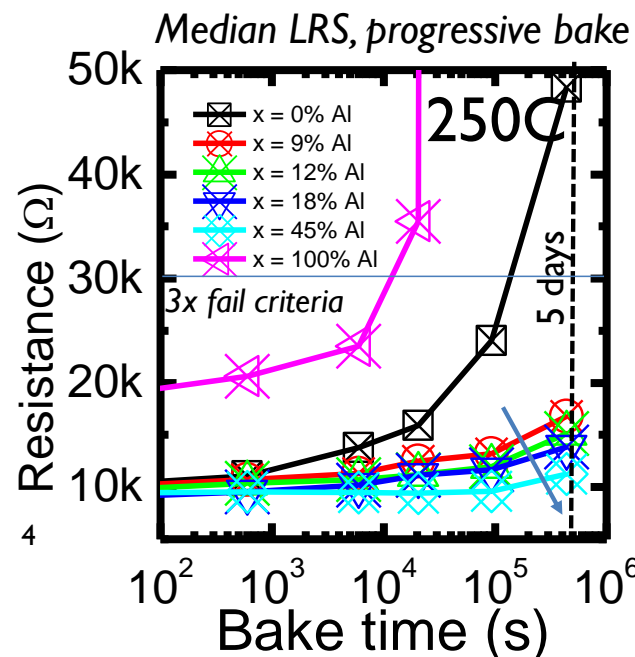


**High
Endurance** *Chen et al.,
TED 59(12) (2012)*

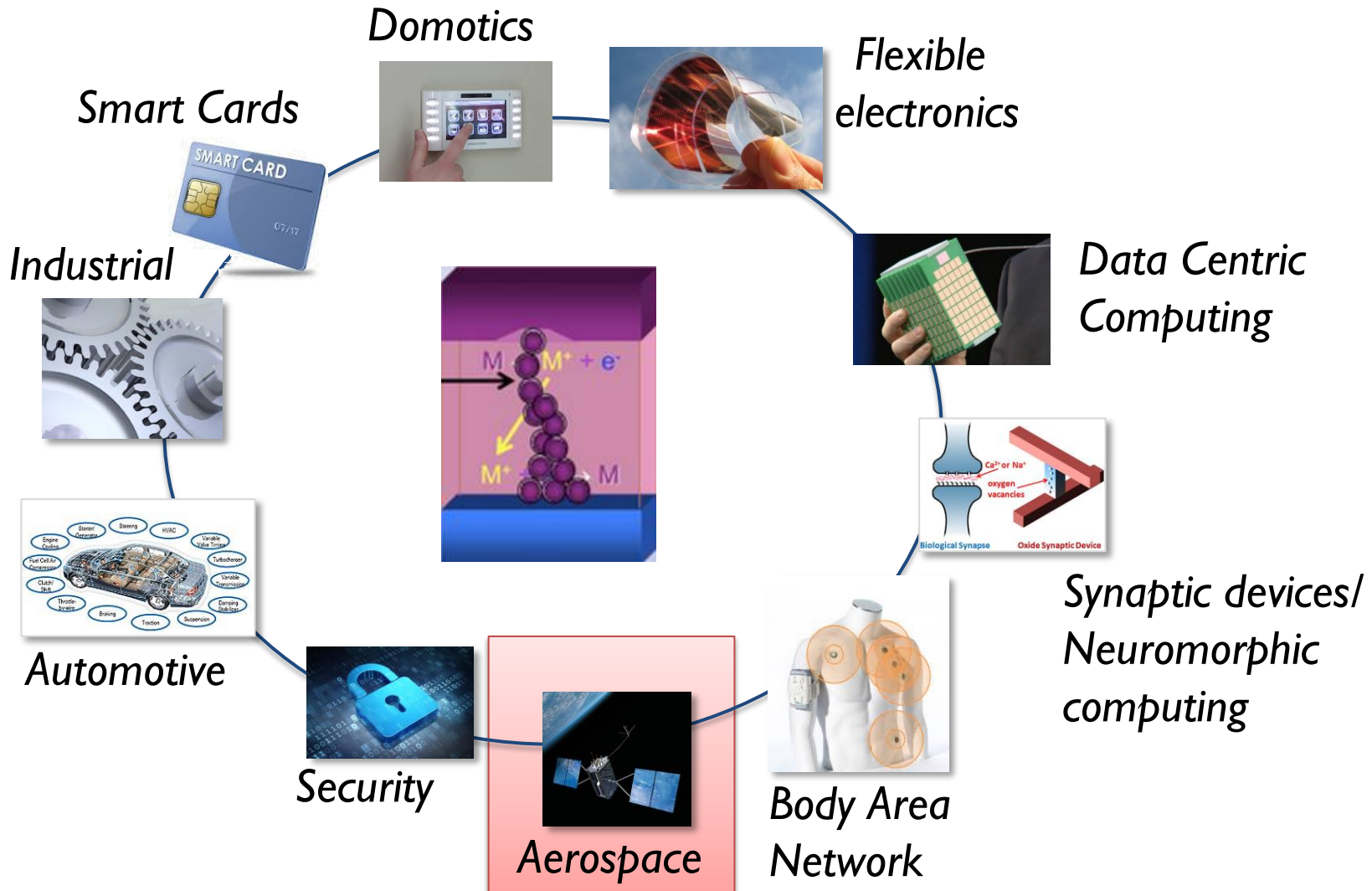
**Good
Retention**

*Fantini et al.,
IMW 2014*

*Many interesting results...
For which applications ?*



POTENTIAL RRAM APPLICATION



RESEARCH GOALS

Many research work on radiation robustness of resistive memory element (filament) alone



However very few research on the robustness of the basic 1T1R cell structure...



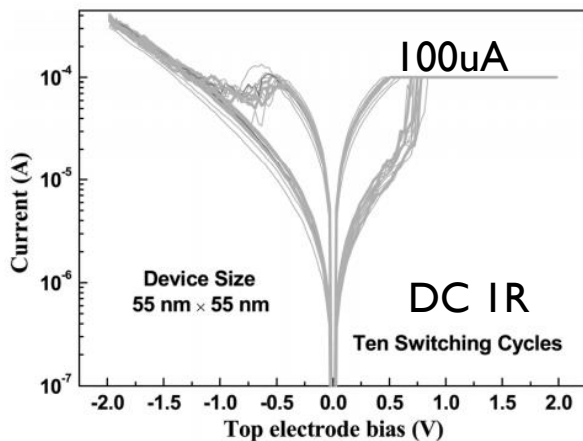
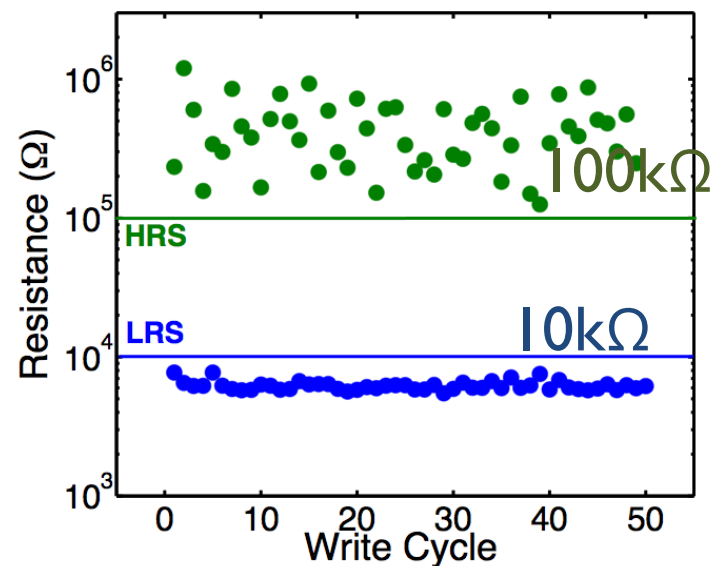
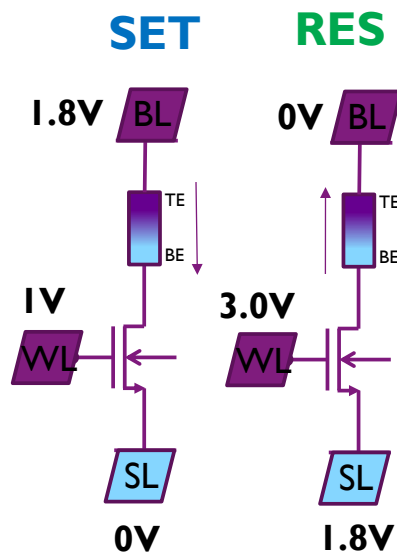
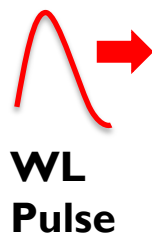
- ▶ For reliable assessment on space application is needed to evaluate 1T – 1R interaction
- ▶ Impact of SEU, TID, DD

BASICS OF RRAM TESTING

Pulsed operation:

5ns Pulse on WL

DC read @ 0.1V
after pulse

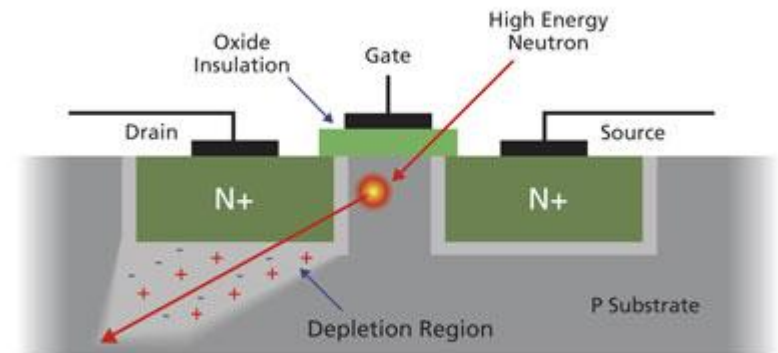


- ▶ Cell functionality assessed by DC and pulse before irradiation
- ▶ Two logic state can be defined

Single Event Effects

RELIABILITY ISSUE

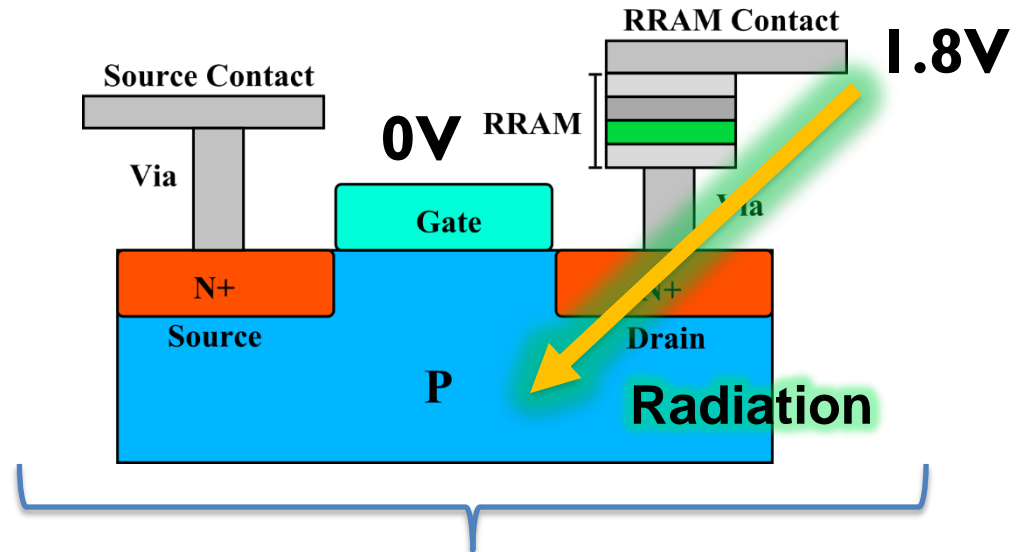
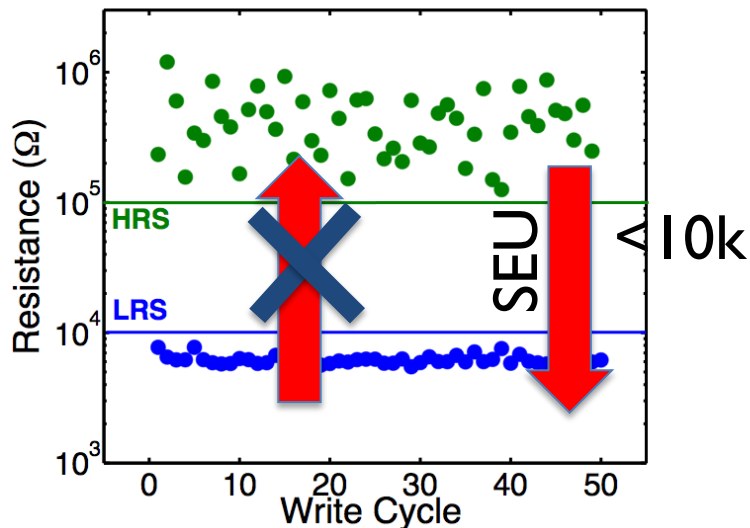
- ▶ Single Event Upsets (SEUs)
 - mobile generated charge collected at a sensitive circuit node that causes the node to change states



Martin Mason, EE Times, May 2006

SEU IN RRAM

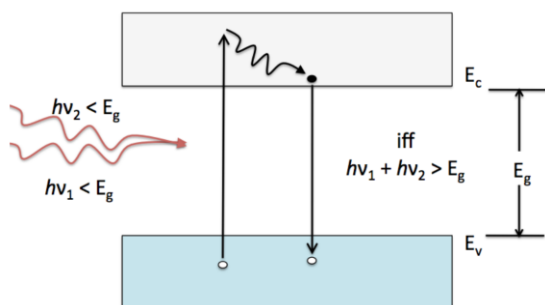
SEU Criteria: $HRS < 10k\Omega$



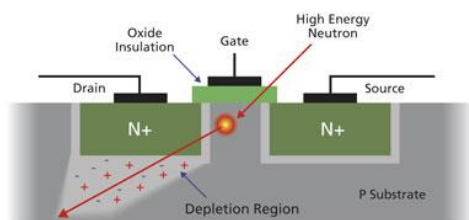
Worst case condition for RRAM:
Unselected cell in HRS state

- ▶ RRAM subject to SEU in HRS state. Voltage spike due to collected charge can trigger HRS-to-LRS transition
- ▶ No SRAM-like regenerative action. *Impact cumulates through multiple events (MEU)*

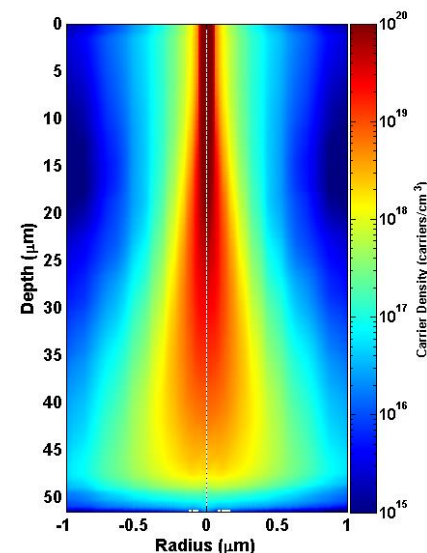
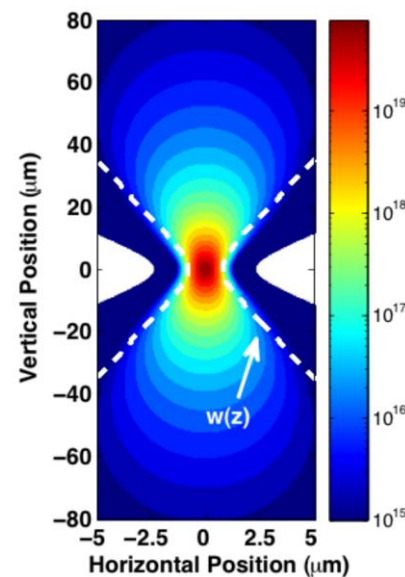
SEU DETECTION BY LASER TESTING



- ▶ Two photons are absorbed to generate an electron-hole pair
- ▶ Goal is to emulate charge generation from heavy-ions



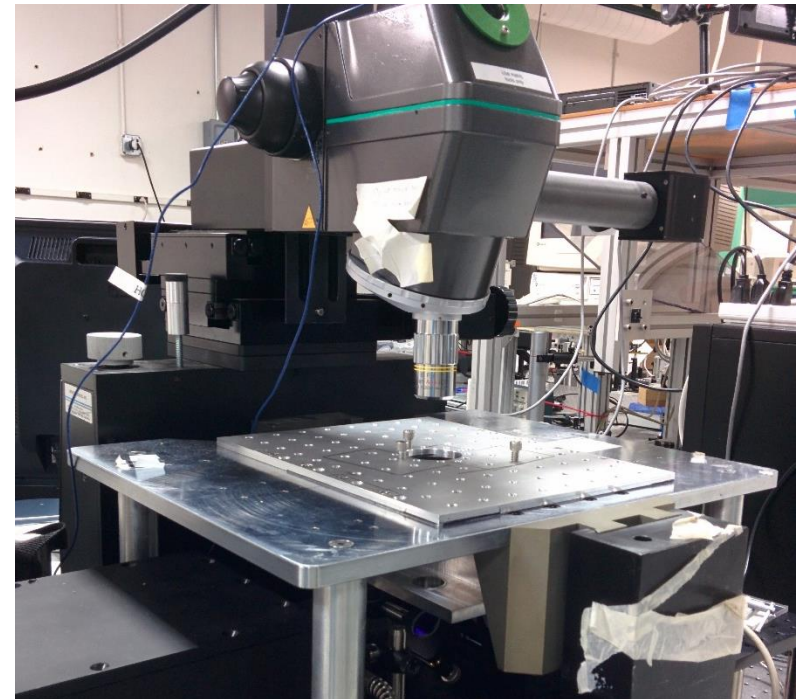
Allows to focus through Si substrate, but generate wide shape of charges



TPA EXPERIMENTAL SETUP

- 1260 nm wavelength
- 150 fs (nominal) pulse width
- 1.2 μm (charge gen spot size)
- 60 pJ-5nJ energy
- 0.1 μm stage resolution in x,y,z

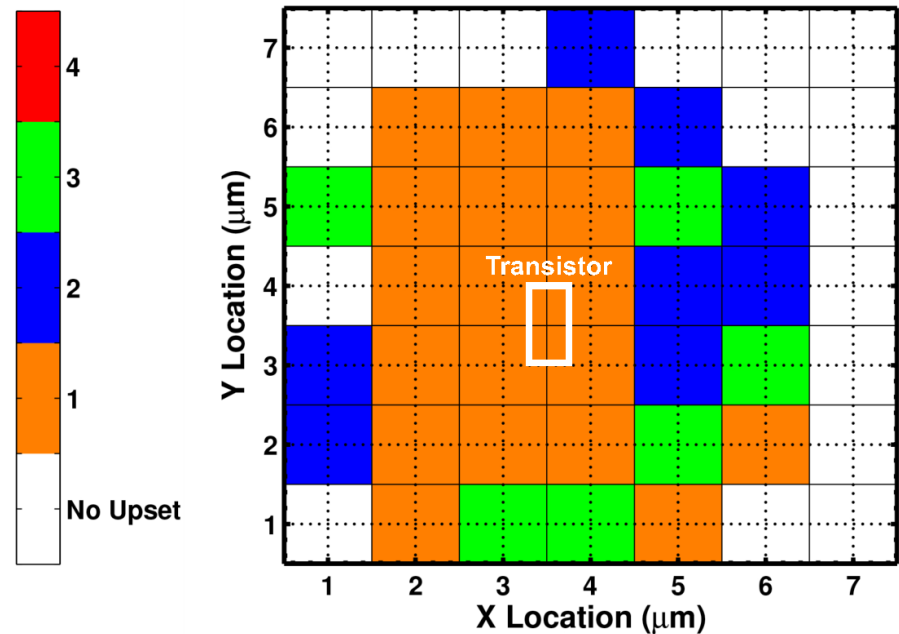
Photodiode to record each incident laser pulse energy



IMPACT OF STRIKE LOCATION ON SEU

Unselected ITIR cell
HRS state, $V_g=0$, $V_B=1.8$

In WC condition a clear dependence of SEU vs strike location can be obtained



Upset events vs strike location

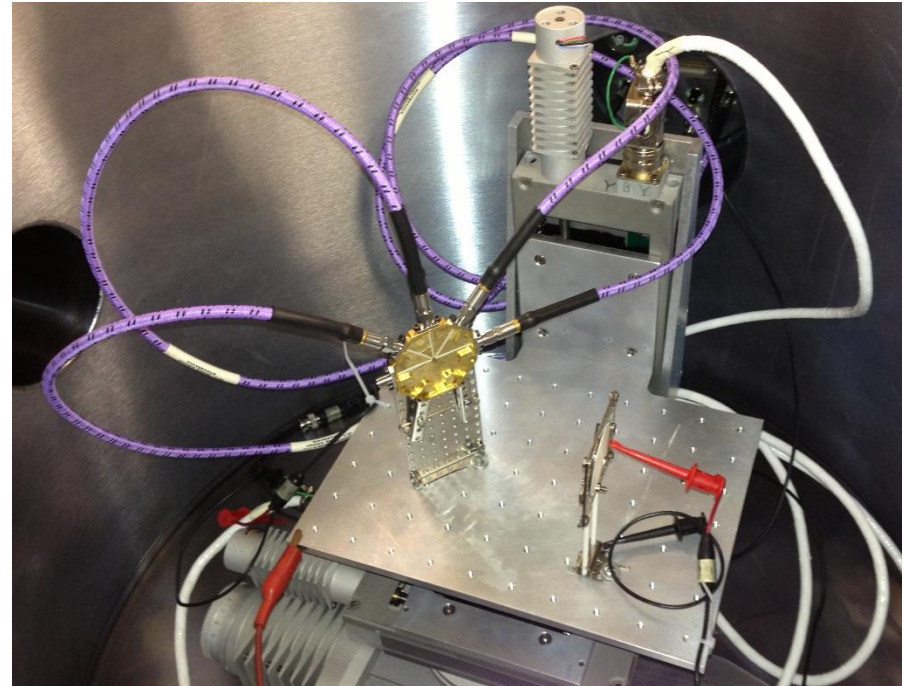
SEU DETECTION BY IRRADIATION

► **Vanderbilt Pelletron**

- 250 keV – 4 MeV protons
- 500 keV – 6 MeV alpha particle
- 14.3 MeV Oxygen
- 16 MeV Chlorine

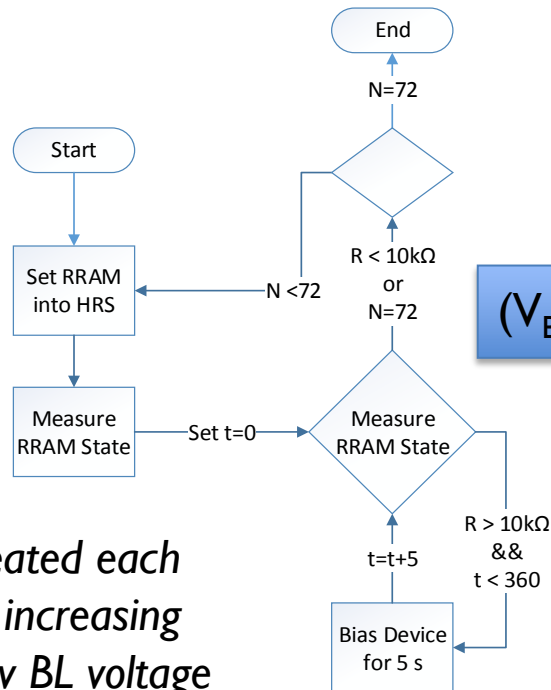
► **Lawrence Berkeley National Lab**

- 4.5, 10, 16 MeV/u ion cocktails



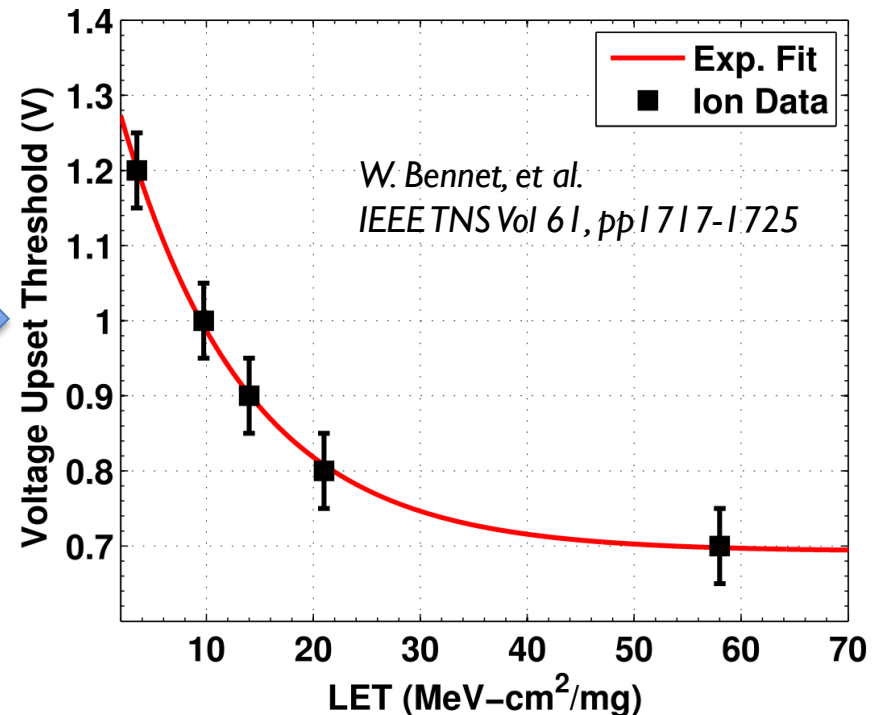
IN SITU SEU MONITORING

Test Flow



Repeated each time increasing 50mv BL voltage

(V_{BL}, LET)



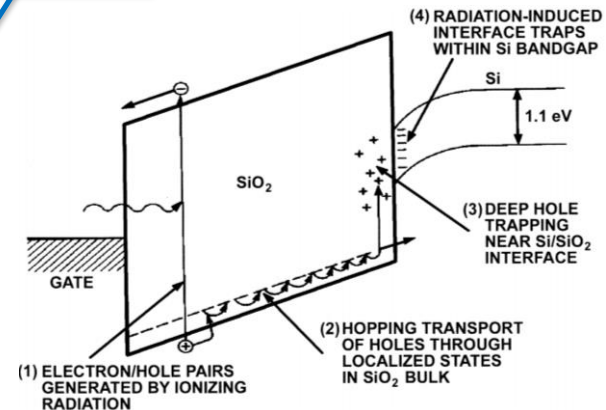
- ▶ ΔR is exponentially related to the applied voltage, likewise the threshold for upset
- ▶ Same as TPA, with 0.7 V minimum voltage for upset

Total Ionizing Dose / Displacement Damage

RELIABILITY ISSUES

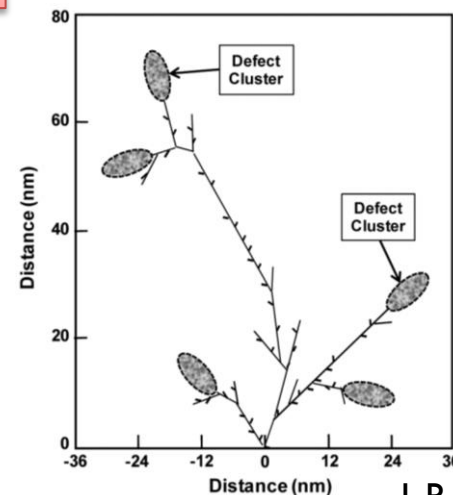
X-rays

- ▶ Total Ionizing Dose (**TID**)
 - radiation generated oxide trapped charge causes devices to perform out of specification (**increased off state current, STI leakage**)



Proton

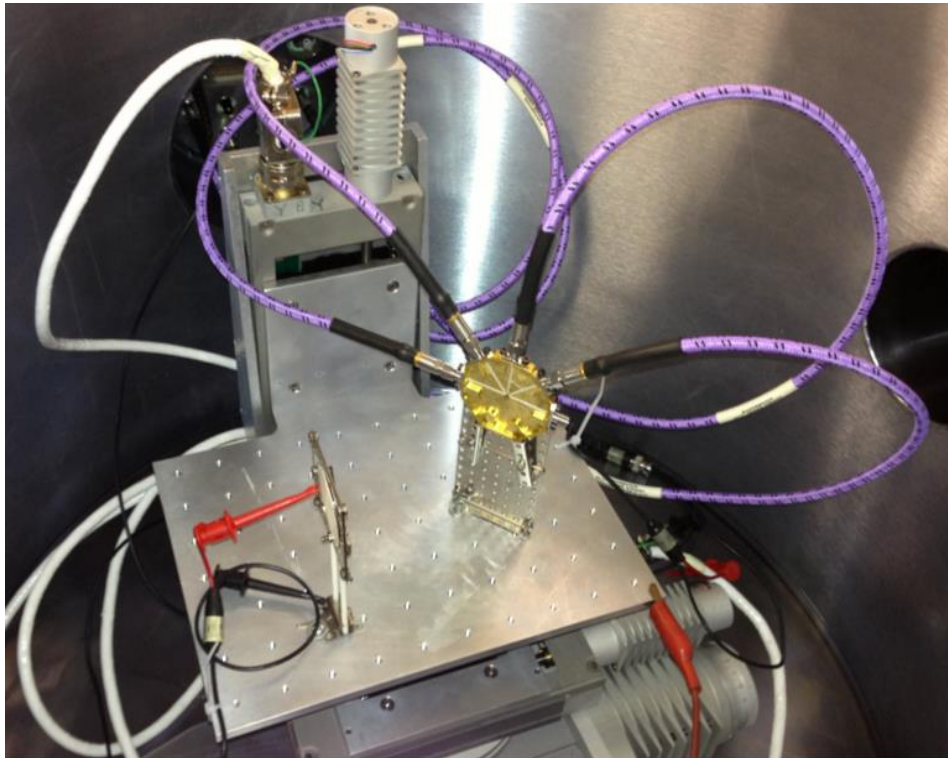
- ▶ Displacement Damage (**DD**)
 - atomic displacements caused by incident particle collisions results in **reduced minority carrier lifetime, as well as reduce mobility**



T. R. Oldham, TNS, June 2003

J. R. Srour, TNS, June 2013

EXPERIMENTAL SETUP



TID testing: 10 keV X-ray
ARACOR irradiator

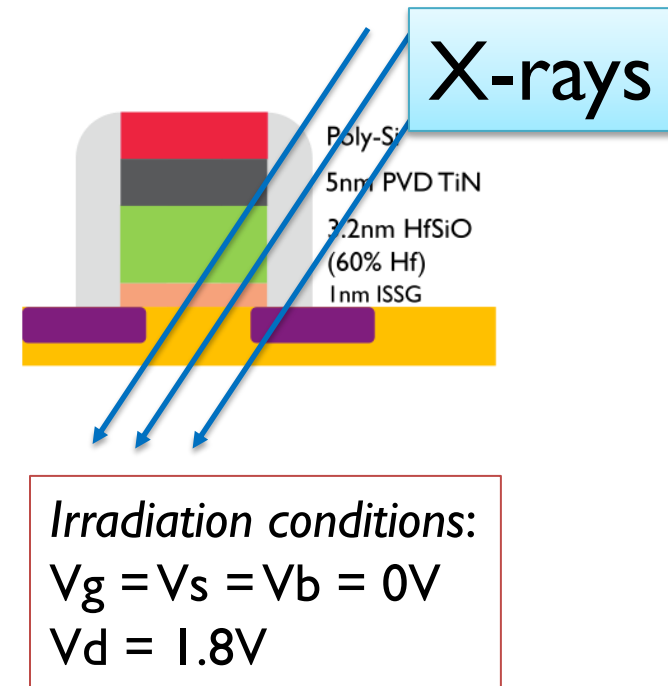
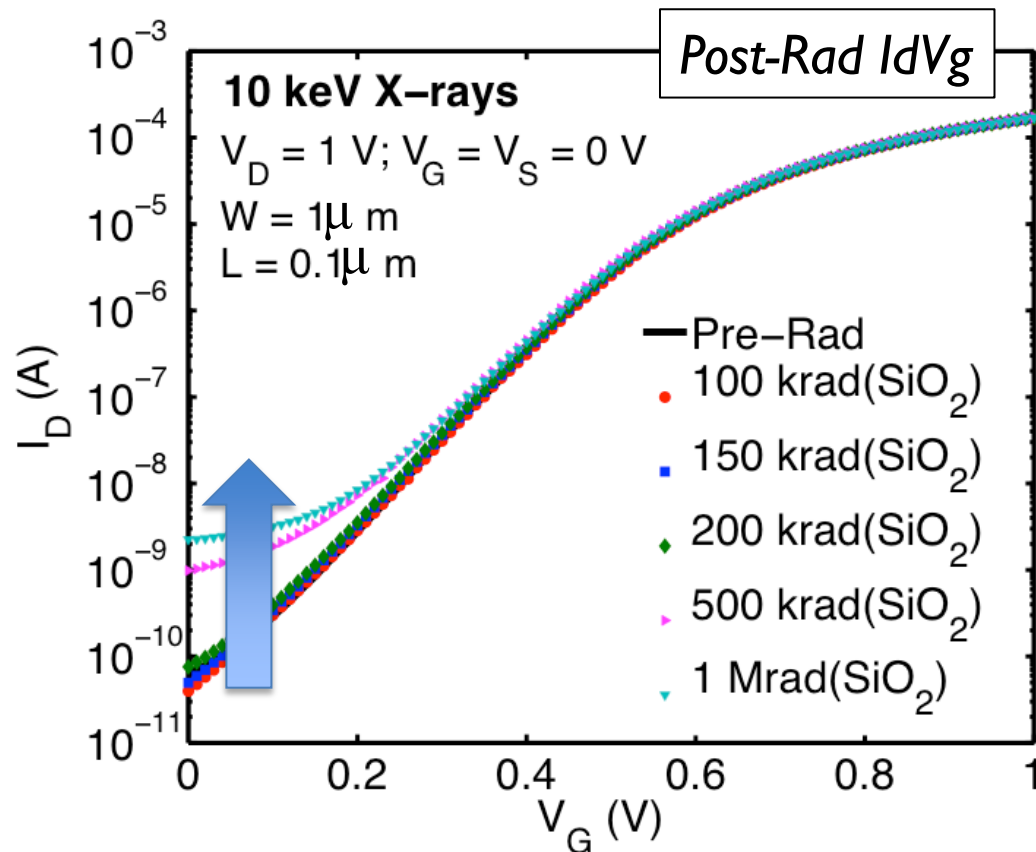
DD testing: Pelletron
accelerator

***50 in-situ AC switching
after each exposure***

- ▶ *Pulsewidth: 5ns*
- ▶ *Voltages: 1.8V SET/RES*

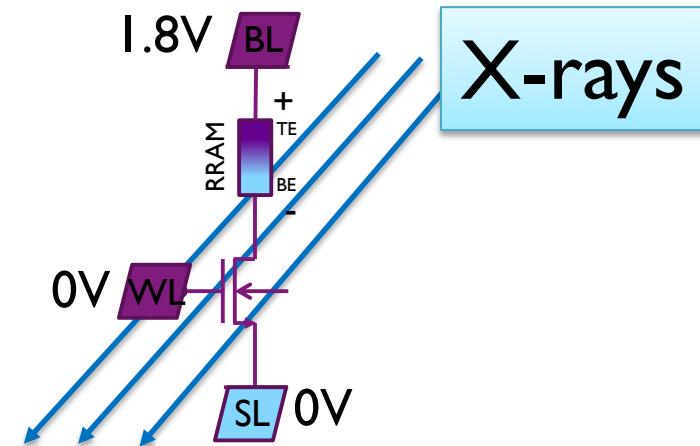
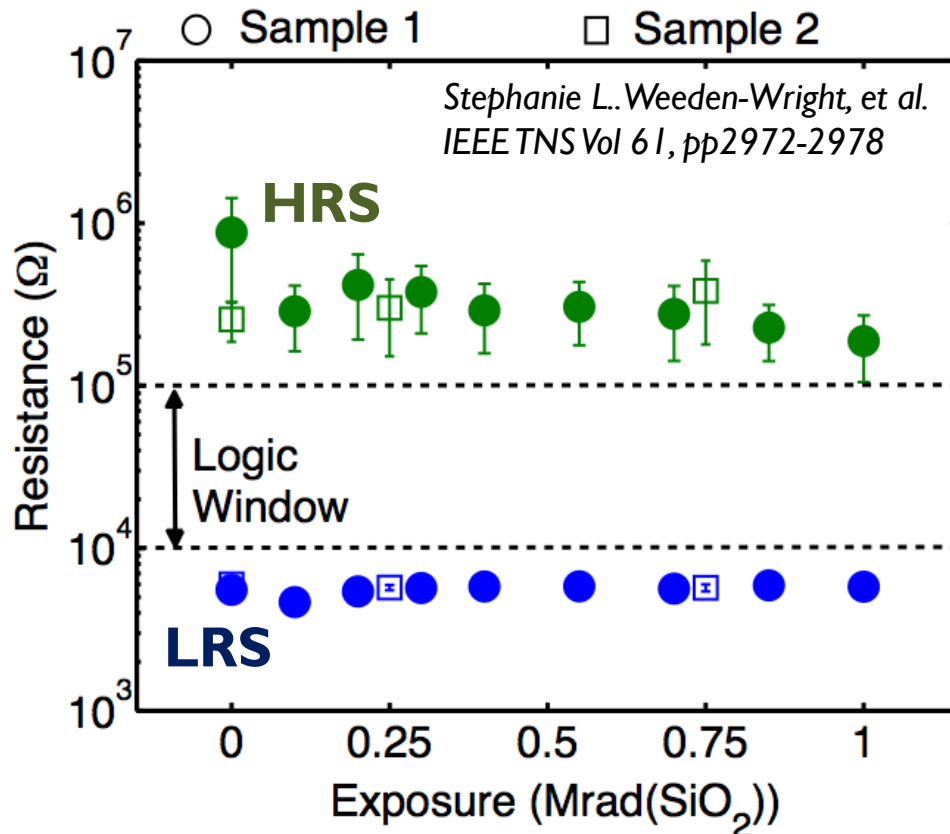
- ▶ High speed package mounted to end station of Vanderbilt's pelletron accelerator

UNHARDENED MOST DEGRADED AFTER TID



- ▶ NMOS biased in off-state during irradiation
- ▶ NMOS IOFF current *degraded*

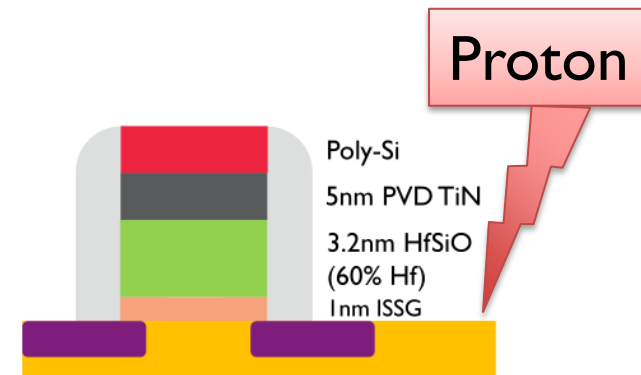
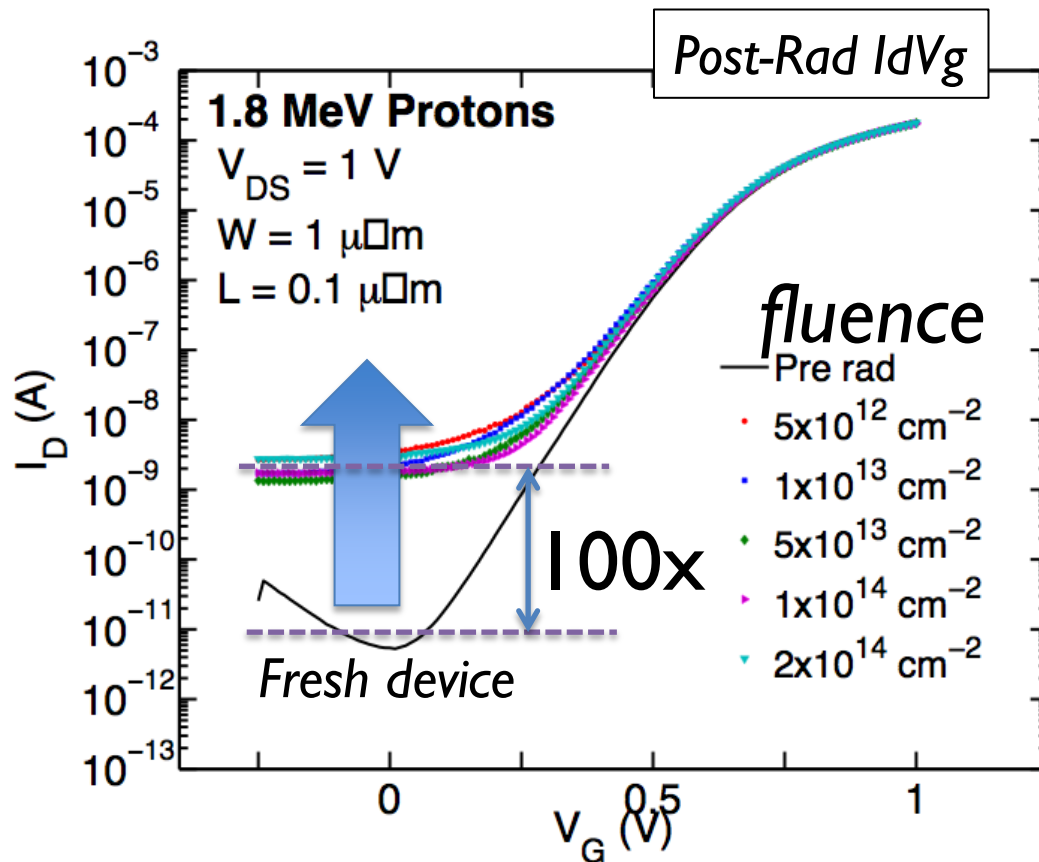
SWITCHING PRESERVED IN ITIR RRAM CELL



Test condition:
PW=5ns, $|V|=1.8V$
50 cycles/exposure
Bias: Unsel.OFF

- ITIR RRAM resistive (logic) window **unaffected** by strong ionizing sources

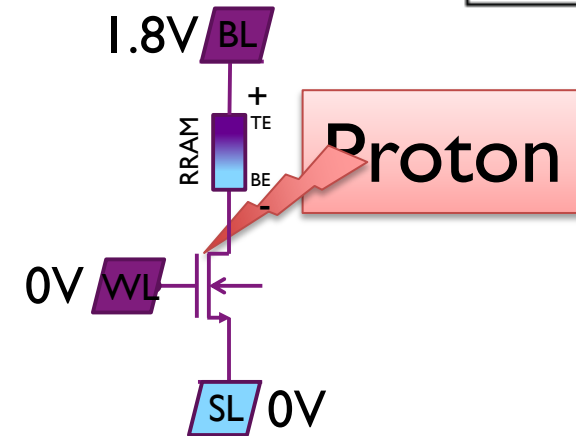
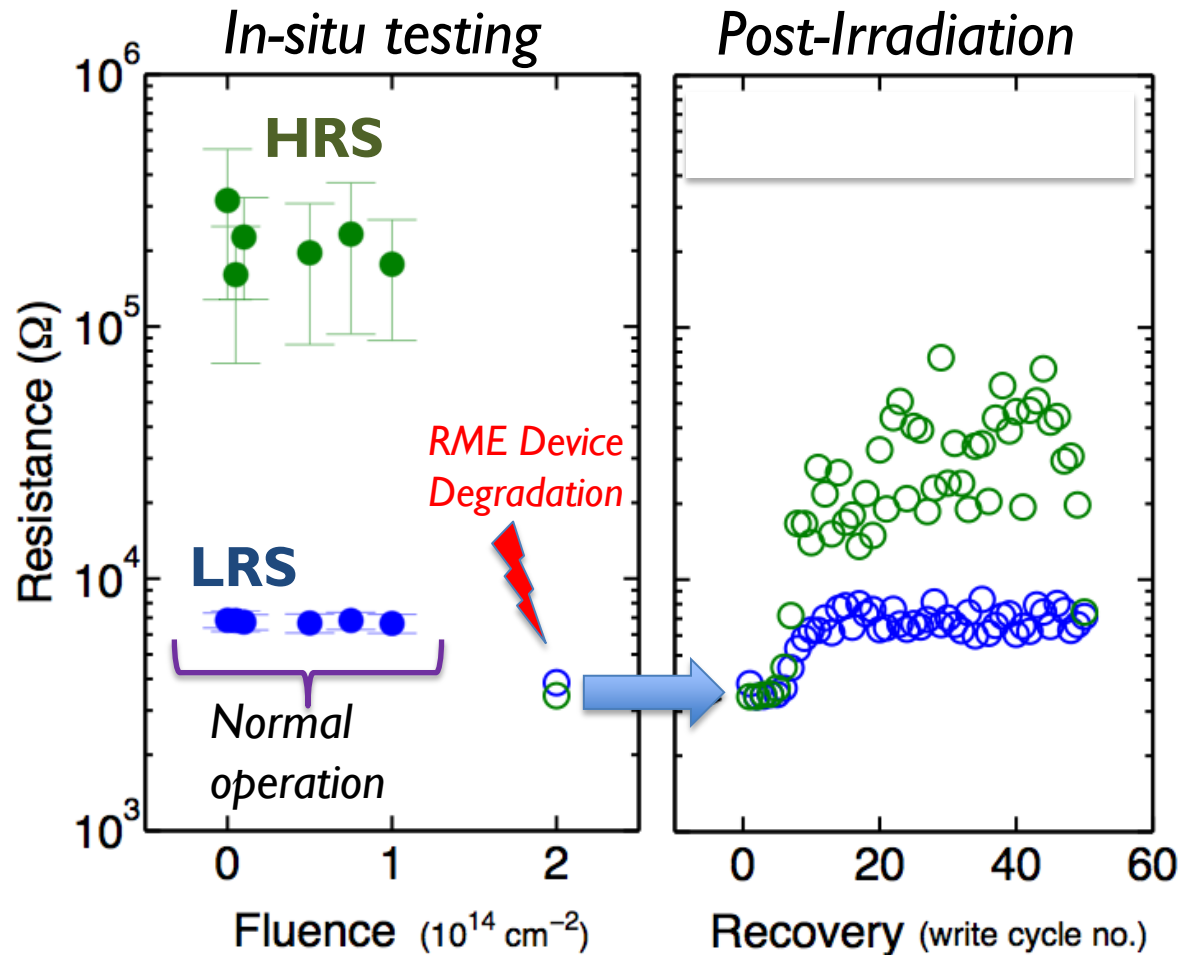
UNHARDENED MOST DEGRADED AFTER DD



Irradiation conditions:
 $V_g = V_s = V_b = 0\text{ V}$
 $V_d = 1.8\text{ V}$

- NMOS IOFF current degraded (factor 100x)

ITIR CELL DEGRADED AT HIGH FLUENCE



Test condition:

PW=5ns, $|V|=1.8V$

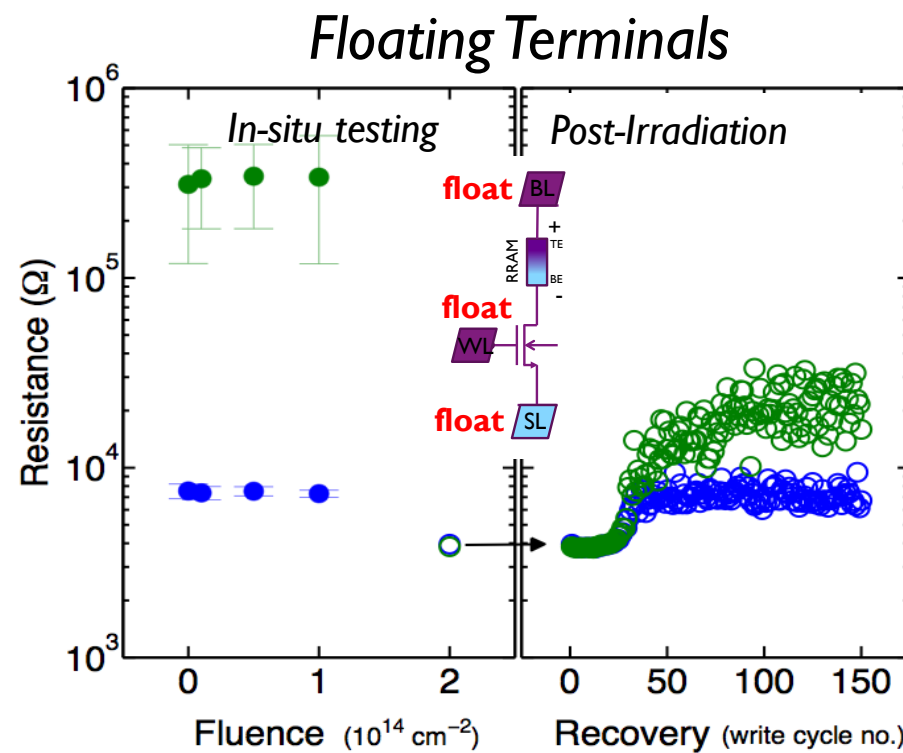
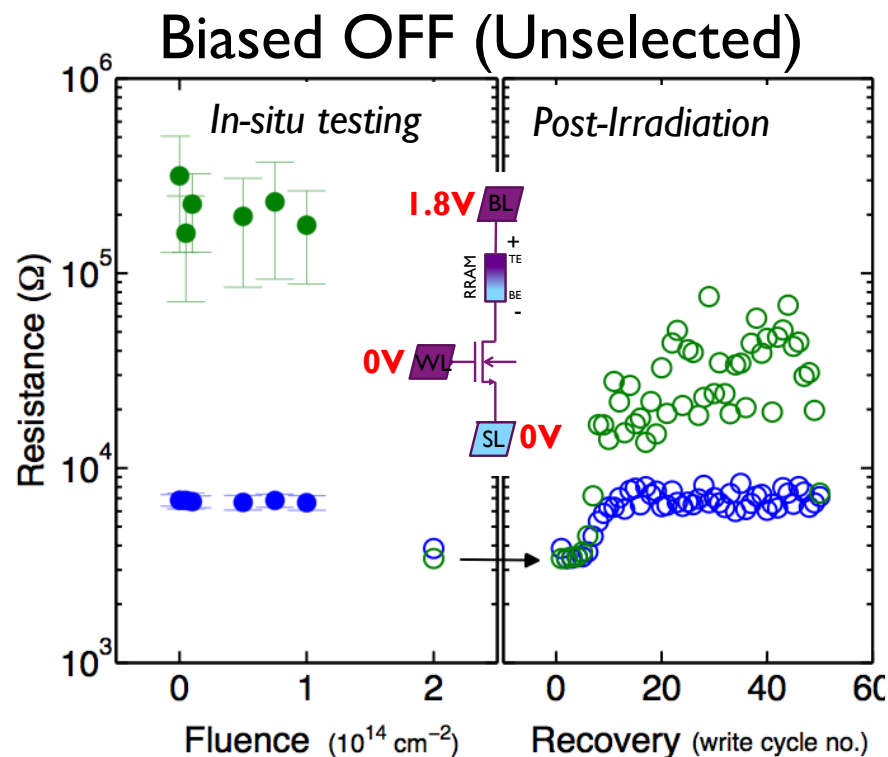
50 cycles/fluence

Bias: Unsel.OFF

**Normal LRS level
can be recovered**

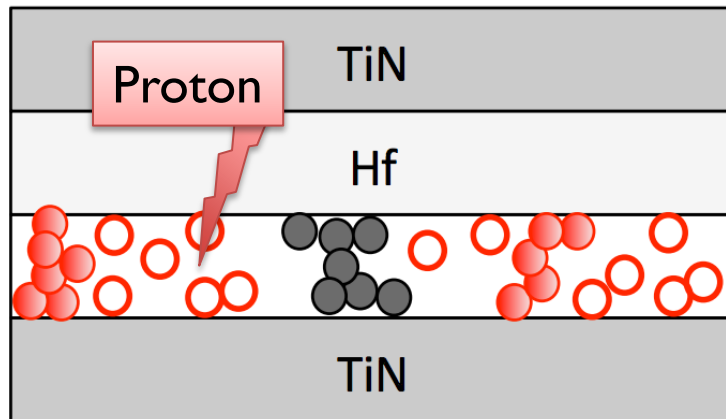
Stephanie L. Weeden-Wright, et al. IEEE TNS Vol 61, pp2972-2978




BIAS INDEPENDENT DEGRADATION



- *Same degradation independently from biasing condition (OFF-biased vs floating terminals)*

PHYSICAL PICTURE

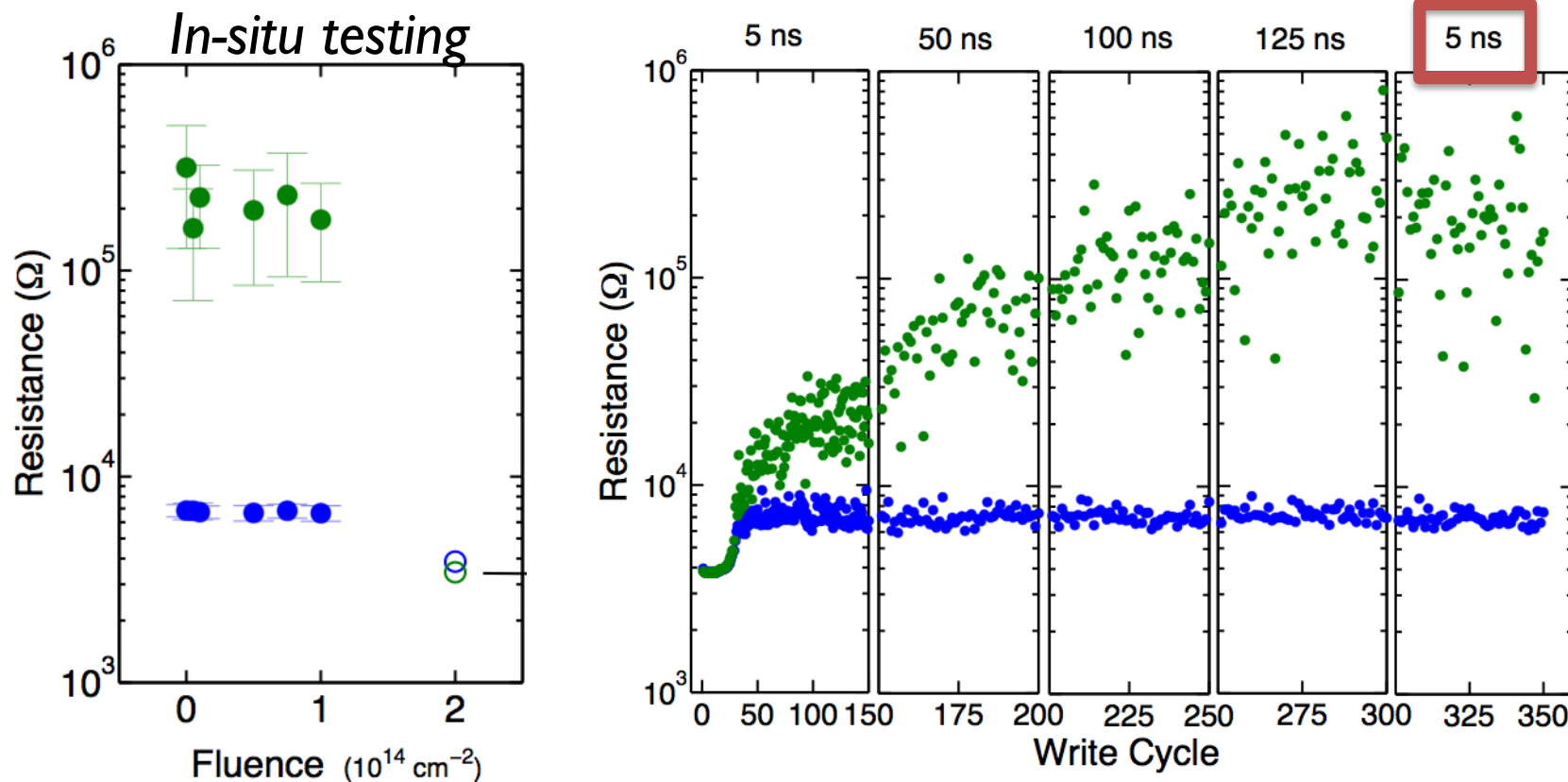


-  Random uniform radiation-induced vacancy
-  Filament formed by random radiation-induced vacancies
-  Original conductive filament

R. Degraeve, *et al.*, IEEE Trans. Electron Devices, vol. 45, no. 4, pp. 904-911, April 1998.

- ▶ Degradation only due to displacement in oxide
- ▶ DD damage randomly generate V_o defects
- ▶ Device degradation apparent only when a percolating path formed in // with filament

DEMONSTRATION OF FULL-RECOVERY



- Pristine resistance window can be recovered
- Short pulse switching restored *after recovery*

OUTLINE

- ▶ Introduction
- ▶ RRAM for space application
- ▶ Reliability: SEU
- ▶ Reliability: TID/DD
- ▶ Conclusion

CONCLUSION

- ▶ Unselected ITIR RRAM cells are vulnerable to SEU in HRS state. LET to trigger depends on BL voltage
- ▶ Damage in access transistor *does not cause degradation* of ITIR RRAM performances.
- ▶ **No degradation** of RRAM performances in TID testing up to high doses (1 Mrad)
- ▶ **Recoverable degradation** of RRAM resistive window in DD test, high fluency condition
 - Attributed to Radiation-Induced percolating path formation of conducting defects → “Burned trough cycling”

VANDERBILT UNIVERSITY ISDE TEAM



Research capabilities:

- Physical modeling of radiation interaction with semiconductors
- Radiation-aware EDA model development
- Rad-hard circuit and IC design

Applications include:

Aeronautics

Aerospace

Defense Systems

Information Technology

Medical

